

SINGLE CHIP RDS DEMODULATOR + FILTER

- HIGH PERFORMANCE, 57KHz BANDPASS FILTER (8th ORDER)
- FILTER ADJUSTMENT FREE AND WITHOUT EXTERNAL COMPONENTS
- PURELY DIGITAL RDS DEMODULATION WITHOUT EXTERNAL COMPONENTS
- ARI (SK INDICATION) AND RDS SIGNAL QUALITY OUTPUT
- 4.332MHz CRYSTAL OSCILLATOR (8.664MHz OPTIONAL)
- LOW NOISE MIXED BIPOLAR/CMOS TECH-NOLOGY

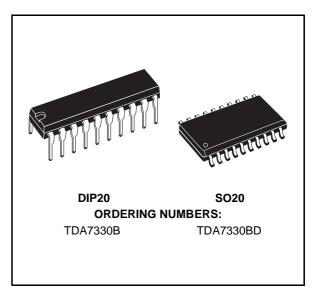
DESCRIPTION

The TDA7330B is a RDS demodulator. It recovers the additional inaudible RDS information which is transmitted by FM radio broadcasting stations.

The output data signal (RDDA) and clock signal (RDCL) can be further processed by a suitable RDS décoder (microprocessor).

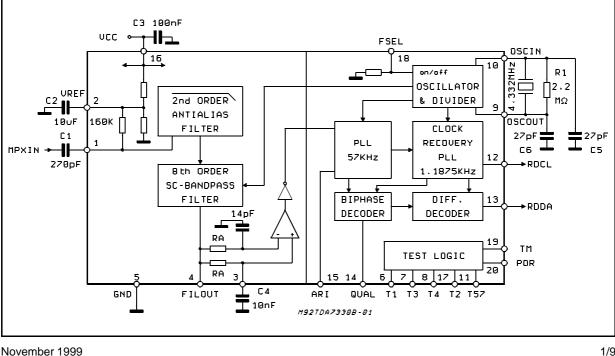
The device operates in accordance with the EBU (European Broadcasting Union) specifications.

The IC includes a 2nd order antialiasing input fil-



ter, a 57KHz switched capacitor band pass filter, a smoothing filter and cross detector, a bit rate clock recovery circuit, a 57KHz PLL, BI-PHASE PSK decoder, differential decoding circuit, ARI indication and RDS signal quality output.

BLOCK DIAGRAM



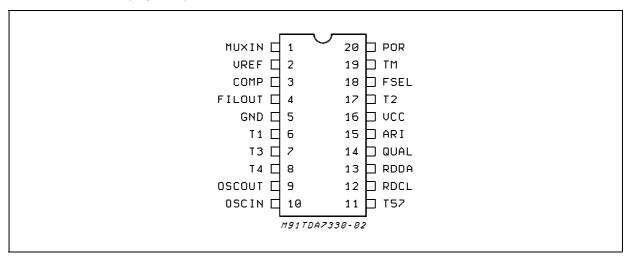
ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|------------------|-----------------------------|------------|------|
| V _{CC} | Supply Voltage | 7 | V |
| T _{op} | Operating Temperature Range | -40 to 85 | °C |
| T _{stg} | Storage Temperature | -40 to 150 | °C |

THERMAL DATA

| Symbol | Description | DIP20 | SO20 | Unit |
|------------------------|---------------------------------------|-------|------|------|
| R _{th j-case} | Thermal Resistance Junction-case Typ. | 100 | 200 | °C/W |

PIN CONNECTION (Top view)



PIN FUNCTION

| Nr. | Name | Description |
|-------------|------------------|---|
| 1 | MUXIN | RDS input signal. |
| 2 | V _{ref} | Reference voltage |
| 3 | COMP | Not inverting comparator input (smoothing filter) |
| | FIL OUT | Filter Output |
| 4 5 6 | GND | Ground |
| 6 | T1 | Testing output pin (not to be used) |
| 7 | Т3 | Testing output pin (not to be used) |
| 8 9 | T4 | Testing output pin (not to be used) |
| 9 | OSC OUT | Oscillator output |
| 10 | OSC IN | Oscillator Input |
| 11 | T57 | Testing output pin: 57KHz clock output |
| 12 | RDCL | RDS clock output (1187.5Hz) |
| 13 | RDDA | RDS data output |
| 14 | QUAL | Output for signal quality indication (High = good) |
| 15 | ARI | Output for ARI indication (High when RDS + ARI signals are present) |
| | | (High when only ARI is present) |
| | | (Low when only RDS is present) |
| | | (indefined when no signal is present) |
| 16 | V _{CC} | Supply Voltage |
| 17 | T2 | Testing output pin (not to be used) |
| 18 | FSEL | Frequency selector pin: open = 4.332MHz, closed to Vcc = 8.664MHz |
| 19 | TM | Test mode pin (open = normal RUN) |
| | | (closed to V_{CC} = Test mode) |
| 20 | POR | Reset Input for testing (active high) |

ELECTRICAL CHARACTERISTICS ($V_{CC} = 5V$, Tamb = 25°C; $R_g = 600\Omega$; fosc = 4.332MHz; $V_{IN} = 20mVrms$ unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Unit |
|-------------------|------------------------|----------------|------|------|------|------|
| SUPPLY | | | | | | |
| V _{CC} | Supply Voltage | | 4.5 | 5 | 5.5 | V |
| Is | Supply Current | | | 9 | | mA |
| R _{POR} | POR Pull Down Resistor | pin 20 | | 40 | | KΩ |
| POR _{ON} | POR Threshold | | | 2.5 | | V |

FILTER(measured an pin 4 FILOUT)

| Fc | Center Frequency | | 56.5 | 57 | 57.5 | KHz |
|-----|---------------------------------|--|----------------|----------------|----------------|-------------------|
| BW | 3dB Bandwidth | | 2.5 | 3 | 3.5 | KHz |
| G | Gain | f = 57KHz | 18 | 20 | 22 | dB |
| A | Attenuation | $\Delta f = \pm 4$ KHz f = 38KHz; V _i = 500mVrms f = 67KHz; V _i = 250mVrms | 18 50 35 | 22 80 50 | | dB dB dB |
| ∆Ph | Phase non linearity | A (see note1) B (see note1) C (see note1) | | 0.5 1 2 | 5 7.5 10 | DEG DEG DEG |
| Ri | Input Impedance | | 100 | 160 | 200 | KΩ |
| S/N | Signal to Noise Ratio | V _i = 3mVrms | 30 | 40 | | dB |
| Vi | Maximum Input Signal Capability | $f = 19KHz; T3 \le -40dB$ (see note2) f = 57KHz (RDS + ARI) | | | 1 50 | Vrms mVrms |
| RL | Load Impedance | Pin 4 | 100 | | | KΩ |

CROSS DETECTOR

| Î | RA | Resistance pin 3-4 | | 15 | 21 | 28 | KΩ |
|---|----|--------------------|--|----|----|----|----|
| | | | | | | | |

OSCILLATOR

| Fosc | Oscillator Frequency | F_{SEL} = Open (*) F_{SEL} = Closed to V _{CC} (**) | | 4.332 8.664 | | MHz MHz |
|------|---------------------------------|--|---|----------------|---|-----------------|
| VCLL | Clock Input level LOW (pin 10) | | | | 1 | V |
| VCLH | Clock Input Level HIGH (pin 10) | | 4 | | | V |
| | Output Amplitude (pin 9) | | | 4.5 | | V _{PP} |

(*) FSEL pin has an internal 40K Ω pull down resistor A 4.332MHz QUARTZ must be used (**) A 8.664MHz QUARTZ must be used. **DEMODULATOR**

Δfo Max Oscillator Deviation FSEL = Open <u>+</u> 1.2 KHz S_{RDS} **RDS** Detection Sensitivity 1 mVrms 3 SARI **ARI Detection Sensitivity** mVrms **RDS Lockup Time** 100 Tlock ms VOH Output HIGH Voltage $I_L = 0.5 \text{mA}$; pins 12, 13, 14, 15 4 V $I_L = 0.5 mA$; pins 12, 13, 14, 15 V Vol Output LOW Voltage 1 Data Rate for RDS RDCL pin 1187.5 Hz f_{RDS} **RDDA Transition versus RDCL** (see figure 2) 4.3 t_D μsec

Note(1):

The phase non linearity is defined as: $\Delta Ph = |-2 \phi f2 + \phi f1 + \phi f3|$

where ϕ fx is the input-output phase difference at the frequency fx (x = 1,2,3)

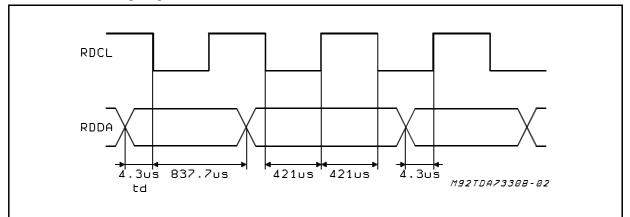
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| Measure | f1 (KHz) | f2 (KHz) | f3 (KHz) | $\Delta \mathbf{Ph} \ \mathbf{max}$ |
|---------|----------|----------|----------|-------------------------------------|
| А | 56.5 | 57 | 57.5 | <5° |
| В | 56 | 57 | 58 | <7.5° |
| С | 55.5 | 57 | 58.5 | <10° |

ELECTRICAL CHARACTERISTICS (continued)

Note(2): The 3th harmonic (57KHz) must be less than -40dB in respect to the input signal 19KHz plus gain.

Figure 2: RDS timing diagram



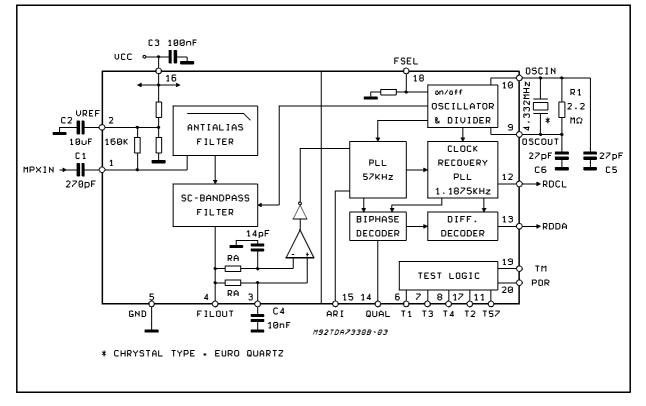
OUTPUT TIMING

The generated 1187.5Hz output clock (RDCL line) is synchronized to the incoming data. According to the internal PLL lock condition this

data change can results on the falling or on the rising clock edge.

Whichever clock edge is used by the decoder (rising or falling edge) the data will remain valid for 416.7 μ sec after the clock transition.

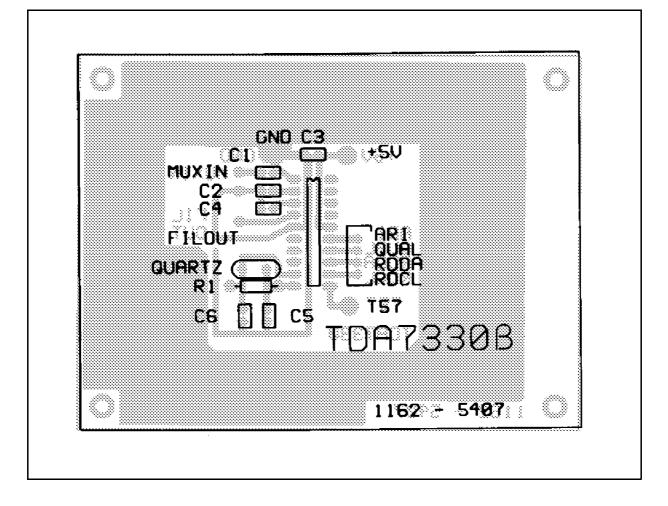
Figure 3: Test Circuit



APPLICATION SUGGESTION

- A good DC decoupling between V_{CC} and GROUND is necessary: a 100nF ceramic capacitor, with low resistance and low inductance at high frequency, directly connected on pin 16 (V_{CC})and 5 (GND) is recommended.
- A small series inductance (100μH) or resistor (27Ω) may be used for supply line filtering.
- The Layout path pin2 C2 pin5 must be as short as possible.
- If the supply line, after the power on has a soft and disturbed (spikes) slope, a capacitor of 100nF, between POR and V_{CC}, is racommended.
- The various testing pins have no sense for the customer.

Figure 4: P.C. board and component layout of fig. 3 (1:1 scale)



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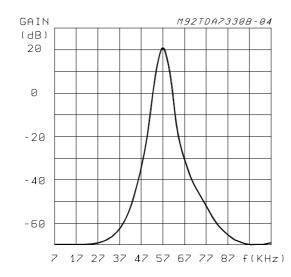
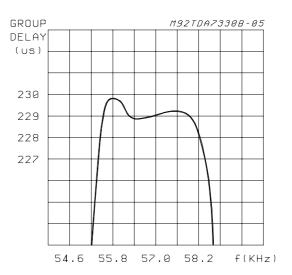
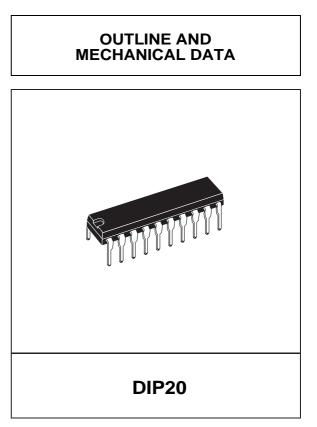


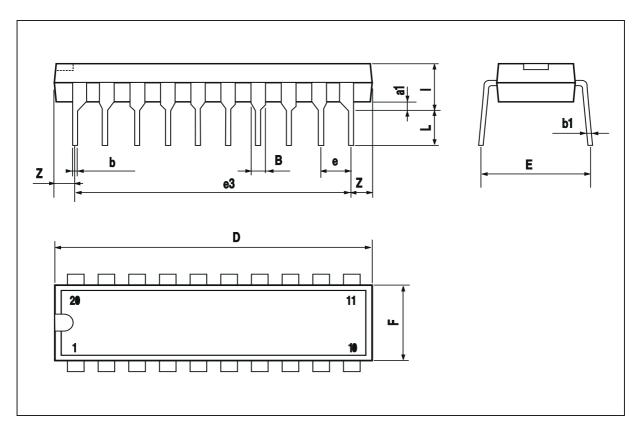
Figure 5: Gain vs. Frequency

Figure 6: Group Delay vs. Frequency



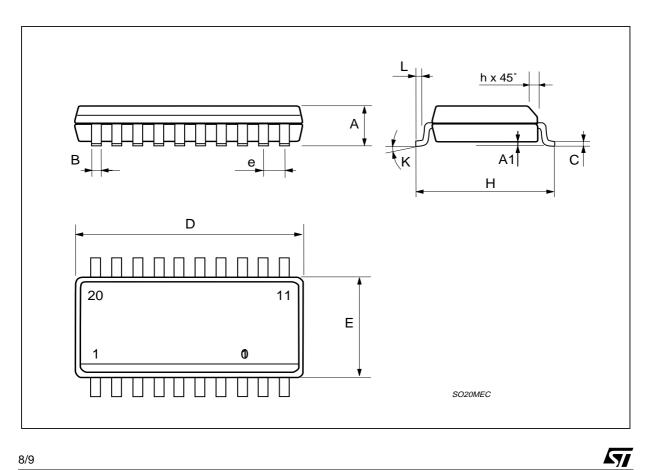
| DIM. | | mm | | inch | | | |
|------|-------|-------|------|-------|-------|-------|--|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. | |
| a1 | 0.254 | | | 0.010 | | | |
| В | 1.39 | | 1.65 | 0.055 | | 0.065 | |
| b | | 0.45 | | | 0.018 | | |
| b1 | | 0.25 | | | 0.010 | | |
| D | | | 25.4 | | | 1.000 | |
| Е | | 8.5 | | | 0.335 | | |
| е | | 2.54 | | | 0.100 | | |
| e3 | | 22.86 | | | 0.900 | | |
| F | | | 7.1 | | | 0.280 | |
| I | | | 3.93 | | | 0.155 | |
| L | | 3.3 | | | 0.130 | | |
| Z | | | 1.34 | | | 0.053 | |





| DIM. | | mm | | | inch | | | | | |
|------|------|--------------------|-------|-------|-------|-------|--|--|--|--|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. | | | | |
| А | 2.35 | | 2.65 | 0.093 | | 0.104 | | | | |
| A1 | 0.1 | | 0.3 | 0.004 | | 0.012 | | | | |
| В | 0.33 | | 0.51 | 0.013 | | 0.020 | | | | |
| с | 0.23 | | 0.32 | 0.009 | | 0.013 | | | | |
| D | 12.6 | | 13 | 0.496 | | 0.512 | | | | |
| E | 7.4 | | 7.6 | 0.291 | | 0.299 | | | | |
| е | | 1.27 | | | 0.050 | | | | | |
| н | 10 | | 10.65 | 0.394 | | 0.419 | | | | |
| h | 0.25 | | 0.75 | 0.010 | | 0.030 | | | | |
| L | 0.4 | | 1.27 | 0.016 | | 0.050 | | | | |
| к | | 0° (min.)8° (max.) | | | | | | | | |

therefore the second **SO20**



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